

TDA18274

Hybrid (analog and digital) silicon tuner for terrestrial and cable TV reception

Rev. 1 — 11 February 2013

Product short data sheet

1. General description

The TDA18274 is a high performance silicon tuner designed for terrestrial and cable TV reception for both analog and digital signals.

The TDA18274 supports all analog and digital TV standards and delivers a Low IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

The TDA18274 facilitates TV design by:

- · Allowing on-board integration
- Drastically reducing the tuner Bill Of Material (BOM)
- Providing flexibility in system solution development
- Allowing straightforward and cost effective multi-tuner applications optimization

2. Features and benefits

- Single 3.3 V supply voltage
- Worldwide multistandard terrestrial and cable capabilities
- Alignment free
- RoHS compliant
- I²C-bus interface compatible with 3.3 V microcontrollers
- Crystal oscillator output buffer as well as Slave Tuner Output (STO) for multiple tuner applications
- Fully integrated oscillators
- Fully integrated RF selectivity (no need for RF tracking filters coils) (TDA18274HD only)
- 2 programmable General-Purpose Outputs (GPO)
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- LIF channel center frequency output ranging from 0.8 MHz to 7.5 MHz
- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Large flexibility in the IF filtering stage to ease the matching with various demodulators circuits
- Single-ended RF input, no need for external balun
- Up to 1 GHz RF input capability
- Excellent return loss compatible with cable requirements
- Power Level Detector (PLD) embedded
- Integrated gain control
- Self-AGC synchronization mode (VSync) for analog reception



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- Very fast tuning timeStrong immunity to LTE interferers in the digital dividend bandwidth
- Strong immunity to WLAN interferers

3. Quick reference data

Table 1. Quick reference data

	au					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f_{RF}	RF frequency	full range of RF input	42	-	1002	MHz
NF _{tun}	tuner noise figure	75 Ω impedance source; maximum gain	-			
		LNA $Z_i = 1$ and RF < 870 MHz		4.0	4.6	dB
		LNA Z _i = 1 and 870 MHz < RF < 1 GHz		5.4	6	dB
Φjit	phase jitter	integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree
$lpha_{ ext{image}}$	image rejection	worst case, measured at 4 MHz IF frequency and for image levels above $60~dB_{\mu}V$	57.5	63	-	dB
CSO	composite second-order distortion	worst interferer over RF frequency with respect to wanted carrier	<u>[1]</u> -	-60	-50	dBc
СТВ	composite triple beat	worst interferer over RF frequency with respect to wanted carrier for frequency ≤ 550 MHz	[1] -	-65	-60	dBc
		worst interferer over RF frequency with respect to wanted carrier for frequency > 550 MHz	[1] -	-	-55	dBc
ICP _{1dB}	1 dB input compression point	at the tuner input and minimum gain	120	-	-	dΒμV

^[1] Test scenario: 129 channels each 75 dB μ V.

4. Ordering information

Table 2. Ordering information

Type number	Package	,			
	Name	Description	Version		
TDA18274HN/C1	HVQFN40	plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body $6\times6\times0.85$ mm	SOT618-6		
TDA18274HD/C1	HLQFN48R	plastic thermal enhanced very thin quad flat package; no leads; 48 terminals; body $7 \times 7 \times 1.15 \text{ mm}$	SOT995-2		

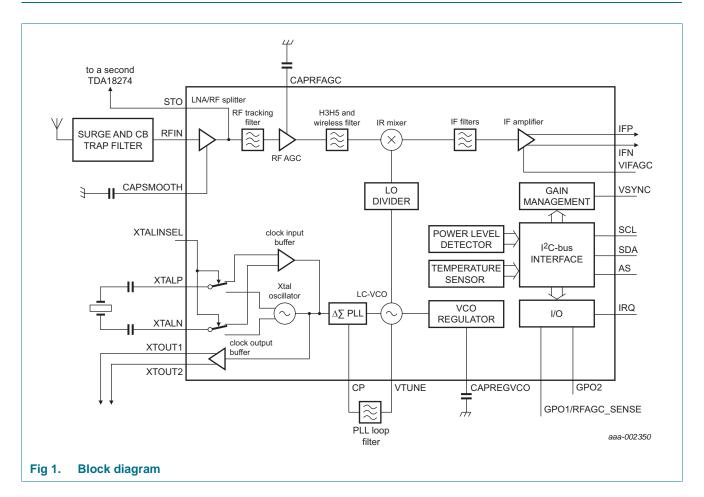
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5. Block diagram



6. Limiting values

Table 3. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.3	+3.6	V
VI	input voltage	V _{CC} < 3.3 V	-0.3	$V_{CC} + 0.3$	V
		V _{CC} > 3.3 V	-0.3	+3.6	V
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
T_{amb}	ambient temperature		-20	<u>[1]</u>	°C
V _{ESD}	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III [2]	750	-	V
GPO pins: GPO1/RFAGC_SENSE and GPO2					
V_{CC}	supply voltage	$0 \text{ V} < \text{V}_{\text{pu}} < 5.5 \text{ V}; \text{R}_{\text{pu}} > 390 \Omega$	-0.3	+5.5	V
I _{CC}	supply current	corresponding GPO ON	-20	0	mΑ

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- [1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I^2C -bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$. where ΔT_{j-c} = power \times R_{th} .
- [2] Class III: 500 V to 1000 V.

7. Abbreviations

Table 4. Abbreviations

Acronym	Description
AGC	Automatic Gain Control
BOM	Bill Of Material
FCDM	Field-induced Charged-Device Model
GPO	General Purpose Outputs
H3H5	Harmonic 3 and Harmonic 5
НВМ	Human Body Model
IF	Intermediate Frequency
I/O	Input/Output
LC-VCO	Inductors and Capacitors - Voltage Controlled Oscillator
LIF	Low IF
LNA	Low-Noise Amplifier
LO	Local Oscillator
LTE	Long-Term Evolution
LTO	Loop-Through Output
PLD	Power Level Detector
PLL	Phase-Locked Loop
RF	Radio Frequency
RoHS	Restriction of Hazardous Substances
SAW	Surface Acoustic Wave
STB	Set-Top Box
STO	Slave Tuner Output
VCO	Voltage Controlled Oscillator
Xtal	Crystal
WLAN	Wireless Local Area Network

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8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA18274_SDS v.1	20130211	Product short data sheet	-	-

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9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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